

DATASHEET

SMD • REFLECTOR 67-03A/R6GHBHW-A01/2T/MS



Features

- Package in 8 mm tape on 7" diameter reel
- Compatible with automatic placement equipment
- Various Compatible with infrared and vapor phase reflow solder process
- 4 Pins for separate control of each chip and better thermal management
- Good color fidelity and brightness uniformity across the viewing angle
- Pb-free
- RoHS compliant

Description

• The 67-03A SMD LED package provides a perfect solution when users need a clear view of signage display with any size board with 3 in 1 full color SMD LEDs which offer smaller pixel pitch between two LEDs to create a high resolution and better contrast with its black surface design.

Applications

- Indoor signage display applications
- Indicator and backlighting for all consumer electronics.
- Gaming equipment.
- General use.



Device Selection Guide

Chip Materials	Emitted Color	Resin Color
AlGaInP	Brilliant Red	
InGaN	Brilliant Green	Water Diffuse
InGaN	Brilliant Blue	_

Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit	
Reverse Voltage	VR	5	V	
Forward Current	IF	R:25 G:25 B:25	mA	
Peak Forward Current (Duty 1/10 @1KHz)	IFP	R:60 G:100 B:100	mA	
Power Dissipation	Pd	R:60 G:95 B:95	mW	
Junction Temperature	Tj	100	$^{\circ}\mathrm{C}$	
Operating Temperature	Topr	- 40 ∼ +85	$^{\circ}\!\mathbb{C}$	
Storage Temperature	Tstg	- 40 ∼ +90	$^{\circ}\mathbb{C}$	
ESD (Classification acc. AEC Q101)	ESDHBM	R:2000 G:150 B:150	V	
Soldering Temperature	Tsol	Reflow Soldering : 260 °C for 10 sec. Hand Soldering : 350 °C for 3 sec.		



Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol		Min.	Тур.	Max.	Unit	Condition
		R	165		288		_
Luminous Intensity	Iv	G	650		1350	mcd	$I_F=20mA$
		В	150		310		
Viewing Angle	$2\theta_{1/2}$			120		deg	$I_F=20mA$
		R		632			
Peak Wavelength	Λp	G		518		nm	$I_F=20mA$
		В		468			
		R	620.5		627.5		
Dominant Wavelength	Λd	G	518.0		533.0	nm	$I_F=20mA$
		В	461.5		471.5		
		R		20			
Spectrum Radiation Bandwidth	$\Delta\lambda$	G		35		nm	$I_F=20mA$
		В		25			
		R	1.7		2.6		
Forward Voltage	V_{F}	G	2.7		3.6	V	$I_F=20mA$
-	•	В	2.7		3.6		
Reverse Current	I_R				10	μΑ	V _R =5V

Note:

1. Tolerance of Luminous Intensity: ±10%

2. Tolerance of Dominant Wavelength: ±1nm

3. Tolerance of Forward Voltage: ±0.1V



Floating Bin(Red) Bin Range of Luminous Intensity

Bin Code	Min.	Max.	Unit	Condition
RA	165	200		
RB	200	240	mcd	$I_F = 20 \text{mA}$
RC	240	288	_	

Bin Range of Dominant Wavelength

Bin Code	Min.	Max.	Unit	Condition
R1	620.5	627.5	nm	$I_F = 20 \text{mA}$

Floating Bin(Green) Bin Range of Luminous Intensity

Bin Code	Min.	Max.	Unit	Condition
GA	650	785		I _F =20mA
GB	785	940		
GC	940	1130	- mcd -	
GD	1130	1350		

Bin Range of Dominant Wavelength

Bin Code	Min.	Max.	Unit	Condition
G1	518.0	523.0	nm	I _F =20mA
G2	523.0	528.0		
G3	528.0	533.0		

Note:

1. Tolerance of Luminous Intensity: ±10%

2. Tolerance of Dominant Wavelength: ±1nm



Floating Bin(Blue) Bin Range of Luminous Intensity

Bin Code	Min.	Max.	Unit	Condition
BA	150	180		I _F =20mA
BB	180	215		
BC	215	260	mcd	
BD	260	310		

Bin Range of Dominant Wavelength

Bin Code	Min.	Max.	Unit	Condition
B1	461.5	466.5		I -20 A
B2	466.5	471.5	- nm	$I_F = 20 \text{mA}$

Note:

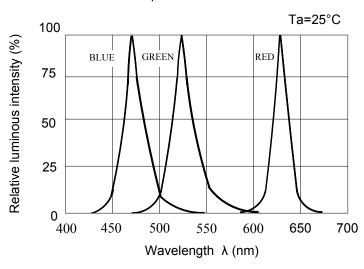
1. Tolerance of Luminous Intensity: ±10%

2. Tolerance of Dominant Wavelength: ±1nm

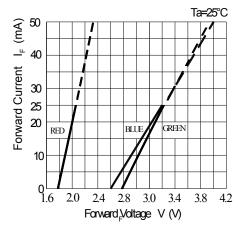


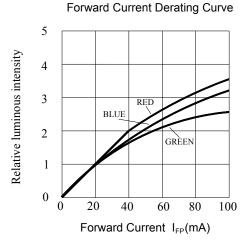
Typical Electro-Optical Characteristics Curves



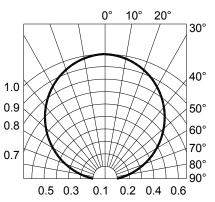


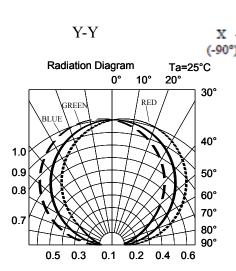
Forward Current vs. Forward Voltage









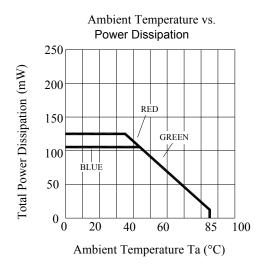


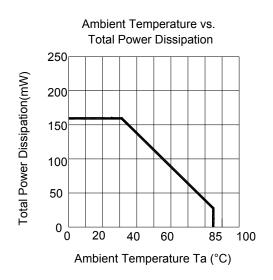
Y(90°)

Y(-90°)

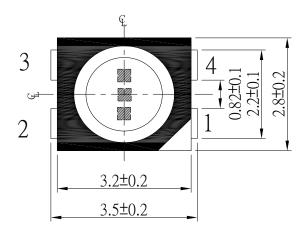


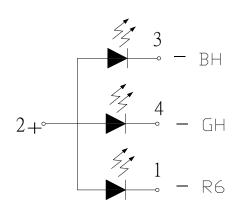
Typical Electro-Optical Characteristics Curves

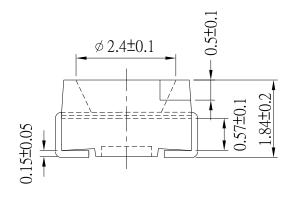


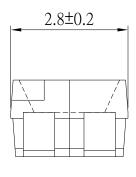


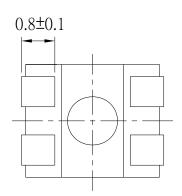
Package Dimension



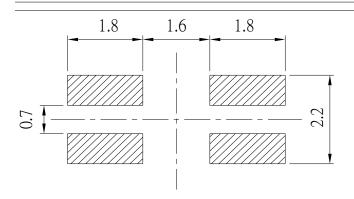








Recommended soldering pad design



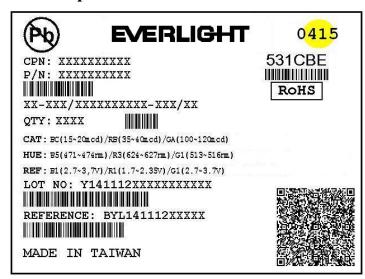
Note:

Tolerances unless mentioned ± 0.1 mm. Unit = mm



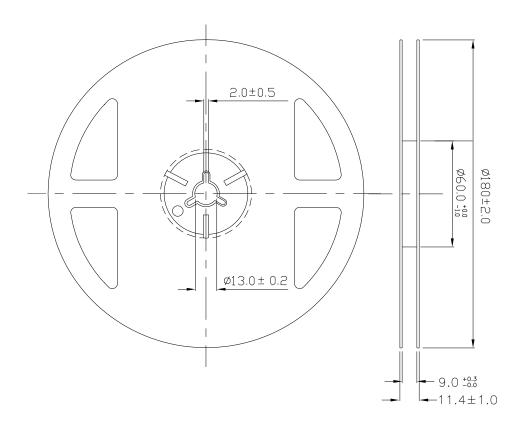
Moisture Resistant Packing Materials

Label Explanation



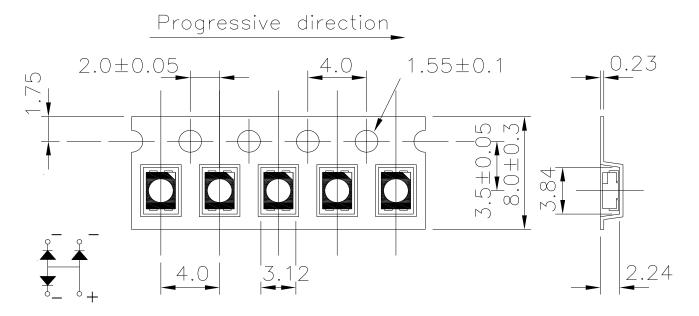
- CPN: Customer's Product Number
- P/N: Product Number
- QTY: Packing Quantity
- CAT: Luminous Intensity Rank
- HUE: Dom. Wavelength Rank
- REF: Forward Voltage Rank
- · LOT No: Lot Number

Reel Dimensions





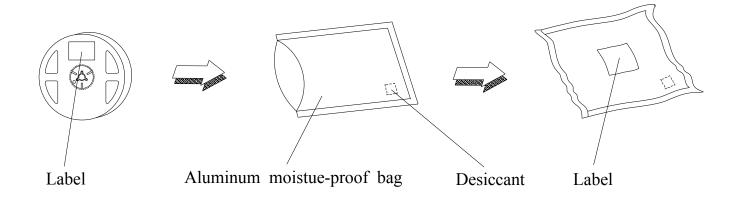
Carrier Tape Dimensions: Loaded Quantity 2000 pcs Per Reel



Note:

Tolerances unless mentioned ± 0.1 mm. Unit = mm

Moisture Resistant Packing Process



Note: Tolerances unless mentioned ±0.1mm. Unit = mm

Precautions for Use

1. Over-current-proof

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Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

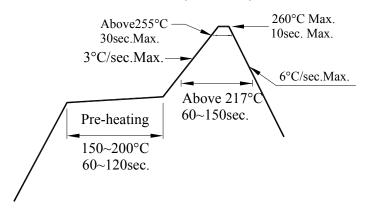
- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be kept at 30℃ or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 168Hrs under 30°C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment : 60±5°C for 24 hours.

2.5 Before using LEDs, baking treatment should be implemented based on the following conditions: pre-curing at $60\pm5^{\circ}$ for 24 hours or $125\pm5^{\circ}$ for 3 hours.

3. Soldering Condition

3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

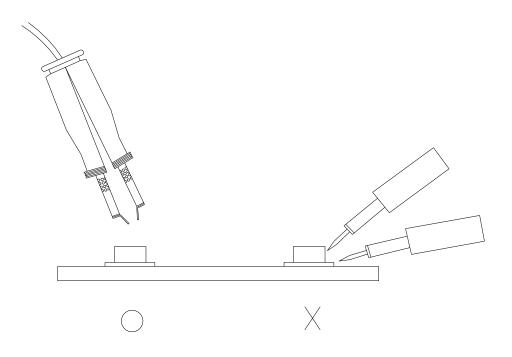
4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.



5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



6.Directions for use

The LEDs should be operated with forward bias. The driving circuit must be designed so that the LEDs are not subjected to forward or reverse voltage while it is off. If reverse voltage is continuously applied to the LEDs, It may cause migration resulting in LED damage.

EVERLIGHT ELECTRONICS CO., LTD.

Office: No 6-8, Zhonghua Rd., Shulin Dist., New Taipei City 23860, Taiwan, R.O.C Tel: 886-2-2685-6688 Fax: 886-2-2685-6699 http://www.everlight.com



DISCLAIMER

- 1. EVERLIGHT reserves the right(s) on the adjustment of product material mix for the specification.
- 2. The product meets EVERLIGHT published specification for a period of twelve (12) months from date of shipment.
- 3. The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
- 4. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from the use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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